

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6179526

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ANIRBAN SINHARROY	04/22/2020
RECEIVING PARTY DATA	
Name:	BOTTOMLINE TECHNOLOGIES (DE) INC
Street Address:	325 CORPORATE DRIVE
City:	PORTSMOUTH
State/Country:	NEW HAMPSHIRE
Postal Code:	03801
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16917161
CORRESPONDENCE DATA	
Fax Number:	(603)869-7480
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	6035014804
Email:	rich.baker@bottomline.com
Correspondent Name:	RICHARD BAKER
Address Line 1:	325 CORPORATE DRIVE
Address Line 4:	PORTSMOUTH, NH 03801, NEW HAMPSHIRE 03801
ATTORNEY DOCKET NUMBER:	BT-144
NAME OF SUBMITTER:	RICHARD A, BAKER, JR.
SIGNATURE:	/RABaker/
DATE SIGNED:	06/30/2020
Total Attachments: 1	
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ASSIGNMENT

For valuable consideration received of the hereinafter named assignee, receipt of which is hereby acknowledged, the undersigned

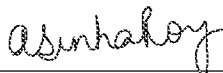
Anirban Sinharoy, 903 Ecostar IT Park Vishweshwar Nagar, Goregaon(E), Mumbai, INDIA

hereby sell and assign to Bottomline Technologies (DE) Inc. a Delaware corporation having a place of business at 325 Corporate Drive, Portsmouth, NH 03801, its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the inventions entitled:

A SYSTEM FOR PROVIDING SCORES TO CUSTOMERS BASED ON FINANCIAL DATA

for which application for United States Letters Patent was executed by the undersigned on the date below and is being filed concurrently herewith, said application for United States Letters Patent, any and all other applications for Letters Patent on said inventions in countries foreign to the United States, including all divisional, renewal, substitute, continuation and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues and extensions of Letters Patent granted for said inventions or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said applications and said Letters Patent; said assignee being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said assignee or otherwise as said assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments being hereby authorized to issue or transfer all said Letters Patent to said assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right heretofore given, and that the undersigned will do all acts reasonably serving to assure that said inventions, patent applications and Letters Patent shall be held and enjoyed by said assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

Signed:



Dated:

22 Apr 2020

Inventor